

V_{DSS}	600V
R _{DS(on)} (Max.)	0.234Ω
I _D	±20A
P _D	76W

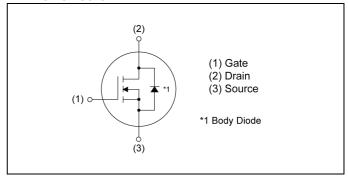
Outline

TO-220FM

Features

- 1) Fast reverse recovery time (trr)
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Drive circuits can be simple
- 5) Pb-free plating; RoHS compliant

•Inner circuit



Application

Switching applications

Packaging specifications

<u>_ </u>	
Packing	Tube
Packing code	C7 G
Marking	R6020JNX
Basic ordering unit (pcs)	2000

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	600	V
Continuous drain current (T _c = 25°C)	I _D *1	±20	А
Pulsed drain current	I _{DP} *2	±60	А
Gate - Source voltage	V _{GSS}	±30	V
Avalanche current, single pulse	I _{AS} *3	4.8	Α
Avalanche energy, single pulse	E _{AS} *3	618	mJ
Power dissipation (T _c = 25°C)	P _D	76	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Downwortow	C. mak al	Values			1.124
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	1.64	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	70	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Darameter	Cumb al	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	600	-	-	V
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$	1	-	100	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30 \text{V}, V_{DS} = 600 \text{V}$	-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 3.5 \text{mA}$	5.0	6.0	7.0	V
Static drain - source on - state resistance	R _{DS(on)} *5	$V_{GS} = 15V, I_D = 10A$ $T_j = 25^{\circ}C$	-	0.180	0.234	Ω
Gate resistance	R_{G}	f = 1MHz, open drain	-	2.0	-	Ω

● Electrical characteristics (T_a = 25°C)

Davamatar	Cumbal	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	1500	1	
Output capacitance	C _{oss}	V _{DS} = 100V	-	90	1	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	1.9	1	_
Effective output capacitance energy related	C _{o(er)} *6	V _{GS} = 0V	-	68	1	pF
Effective output capacitance time related	C _{o(tr)} *7	V _{DS} = 0V to 480V	-	270	1	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \simeq 300V$, $V_{GS} = 15V$	-	29	1	
Rise time	t _r *5	I _D = 10A	-	22	ı	no
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 30.1\Omega$	-	56	1	ns
Fall time	t _f *5	$R_G = 10\Omega$	-	13	ı	

● Gate charge characteristics (T_a = 25°C)

Doromotor	Cumbal	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≈ 300V	-	45	-	
Gate - Source charge	Q _{gs} *5	I _D = 20A	-	15	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 15V	-	17	-	
Gate plateau voltage	V _(plateau)	V _{DD} ≈ 300V, I _D = 20A	-	9.5	-	V

^{*1} Limited only by maximum temperature allowed.

^{*2} Pw \leq 10µs, Duty cycle \leq 1%

^{*3} L \simeq 50mH, V_{DD} = 50V, R_G = 25 Ω , starting T_i = 25°C

^{*4} Tc=25°C

^{*5} Pulsed

^{*6} Co(er) is a fixed capacitance that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .

^{*7} Co(tr) is a fixed capacitance that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .

●Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Source current	I _S *1	T _C = 25°C	1	-	20	Α
Pulsed source current	I _{SP} *2	1C - 23 C	1	-	60	Α
Source-Drain voltage	V _{SD} *5	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.7	V
Reverse recovery time	t _{rr} *5		-	85	-	ns
Reverse recovery charge	Q _{rr} *5	I _S = 20Α di/dt = 100Α/μs	-	280	-	nC
Peak reverse recovery current	_{rr} *5		-	7.5	-	А

Fig.1 Power Dissipation Derating Curve

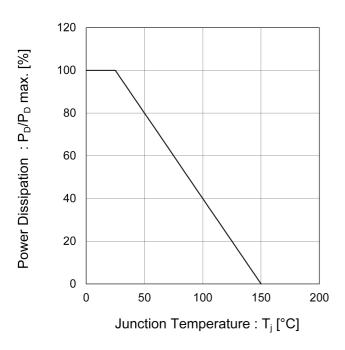


Fig.2 Drain Current Derating
Curve vs. Junction Temperature

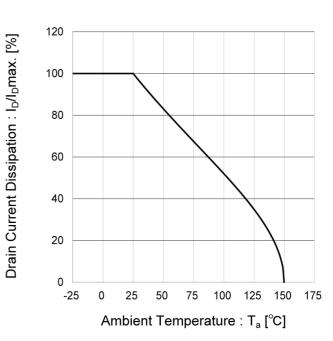


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

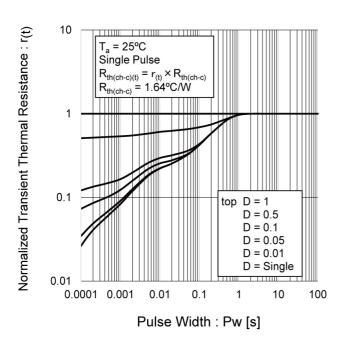


Fig.4 Maximum Safe Operating Area

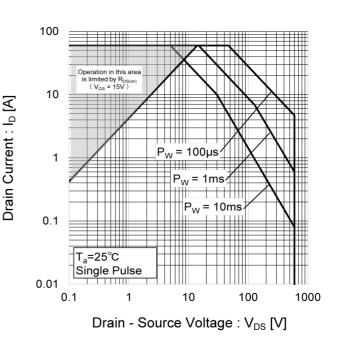


Fig.5 Avalanche Energy Derating
Curve vs. Junction Temperature

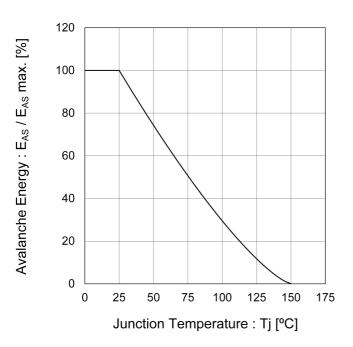


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

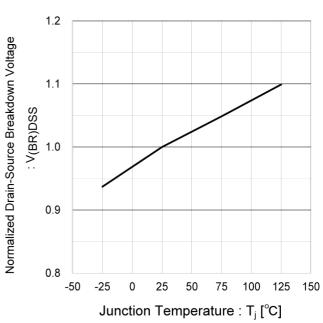


Fig.7 Typical Output Characteristics(I)

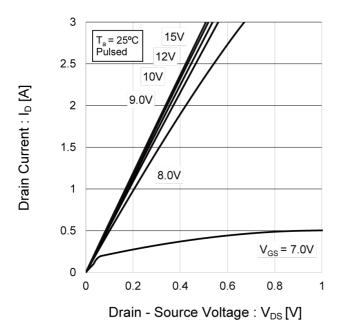
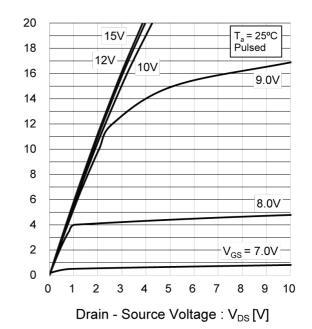


Fig.8 Typical Output Characteristics(II)



Drain Current : I_D [A]

Fig.9 Typical Transfer Characteristics

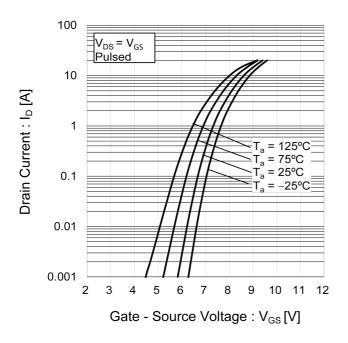


Fig.10 Normalized Gate Threshold .

Voltage vs Junction Temperature

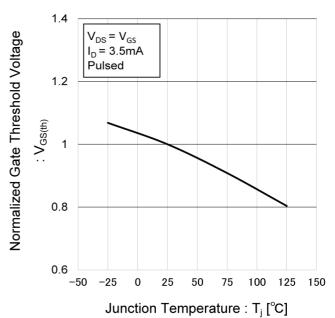


Fig.11 Static Drain - Source On - State Resistance vs. Gate Source Voltage

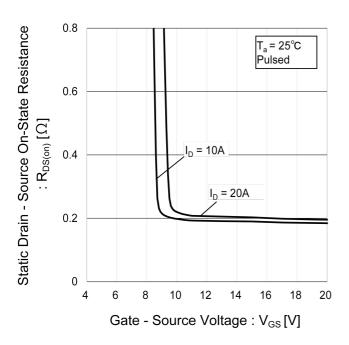


Fig.12 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature

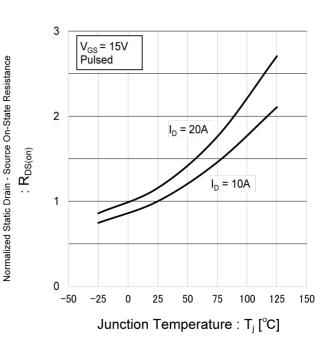


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current(I)

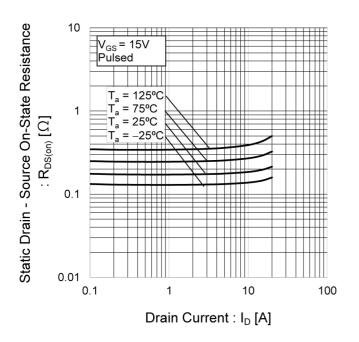


Fig.14 Typical Capacitance vs.

Drain - Source Voltage

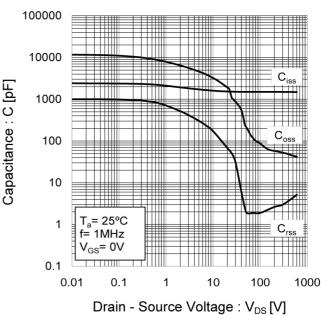


Fig.15 Typical Coss Stored Energy

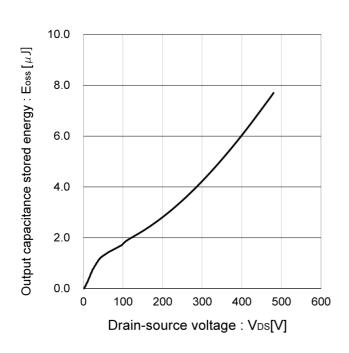
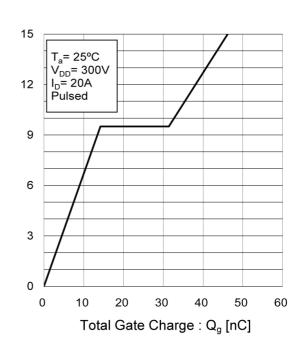


Fig.16 Dynamic Input Characteristics



Gate - Source Voltage : V_{GS} [V]

Fig.17 Inverse Diode Forward Current vs. Source - Drain Voltage

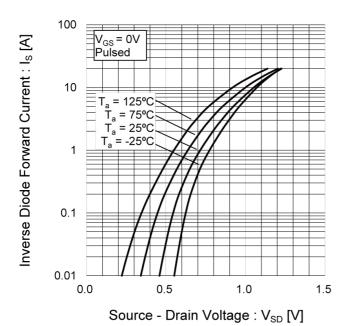
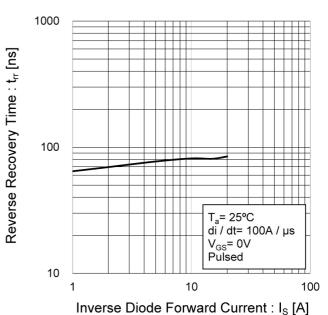


Fig.18 Reverse Recovery Time vs.
Inverse Diode Forward Current





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

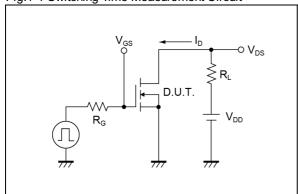


Fig.2-1 Gate Charge Measurement Circuit

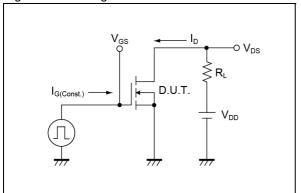


Fig.3-1 Avalanche Measurement Circuit

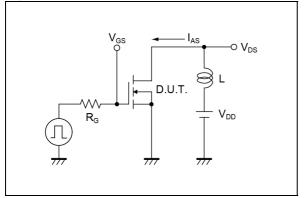


Fig.4-1 Diode Recovery Measurement Circuit

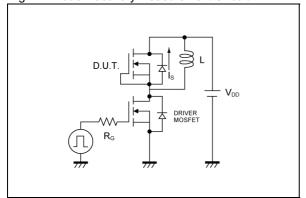


Fig.1-2 Switching Waveforms

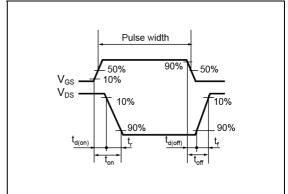


Fig.2-2 Gate Charge Waveform

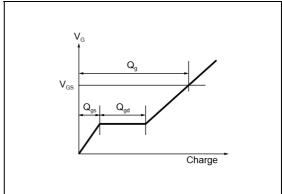


Fig.3-2 Avalanche Waveform

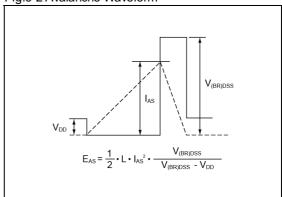
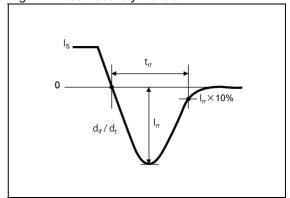
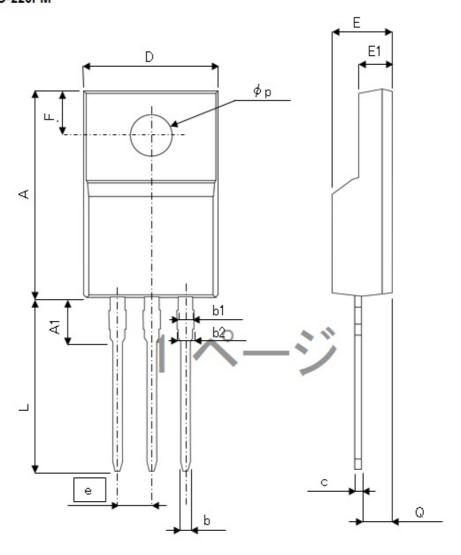


Fig.4-2 Diode Recovery Waveform



Dimensions

TO-220FM



DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	15.67	16.27	0.617	0.641
A1	3.03	3.43	0.119	0.135
Ь	0.70	0.95	0.028	0.037
Ь1	1.00	1.40	0.039	0.055
ь2	1.10	1.50	0.043	0.059
С	0.45	0.65	0.018	0.026
D	9.90	10.30	0.390	0.406
E	4.60	5.00	0.181	0.197
E1	2.44	2.74	0.096	0.108
е	2.	54	0.1	00
F	3.10	3.50	0.122	0.138
L	12.6	13.6	0.496	0.535
р	2.98	3.38	0.117	0.133
Q	2.25	3.25	0.089	0.128

Dimension in mm / inches



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JÁPAN	USA	EU	CHINA
CLASSⅢ	CL A C C TT	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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R6020JNX - Web Page

Distribution Inventory

Part Number	R6020JNX
Package	TO-220FM
Unit Quantity	2000
Minimum Package Quantity	50
Packing Type	Tube
Constitution Materials List	inquiry
RoHS	Yes